

**INFORMATION  
DISCLOSURE  
STATEMENT**

Application No.: 10/822,891

Sheet 1 of 1

Docket No.: SNY-T5707.02

Group: 2423

Filed: 04/13/2004

Conf. No.: 4007

Applicant: Candelore et al.



**U.S. PATENT DOCUMENTS**

Exam. Init.	Document Number	Issue/Pub. Date	Name	Class	Filing Date
	5,159,633	10/27/1992	Nakamura		01/15/1991
	2003/0152232	08/14/2003	Pirila et al.		6/25/2001
	2007/0006253	01/04/2007	Pinder et al.		06/29/2005
	7,490,236	02/10/2009	Wasilewski		01/14/2004
	7,496,198	02/24/2009	Pinder et al.		12/06/2005
	7,555,123	06/30/2009	Pinder et al.		04/29/2005

**FOREIGN PATENT DOCUMENTS**

Exam. Init.	Document Number	Date	Country	Class	Translation
	JP 61-264371	11/22/1986	Japan		Yes**

\*\* Partial translation submitted in IDS 4/6/2010.

**OTHER DOCUMENTS / CITATIONS**

Exam. Init.	Document

Examiner:

Date:

## APPENDIX

These references are cited in one or more applications related to this patent application in US Office Actions. In some instances, art cited in this and other IDS may not constitute prior art to the present application. Below is a list of references received with reference to the corresponding application number.

Document Number	Issue/Pub. Date	Name	Filing Date	Disclosure from
2003/0152232	08/14/2003	Pirila et al.	06/25/2001	US Application No. 11/891,209
7,490,236	02/10/2009	Wasilewski	01/14/2004	US Application No. 11/526,316
7,496,198	02/24/2009	Pinder et al.	12/06/2005	US Application No. 11/526,316
7,555,123	06/30/2009	Pinder et al.	04/29/2005	US Application No. 11/526,316
2007/0006253	01/04/2007	Pinder et al.	06/29/2005	US Application No. 11/526,316
5,159,633	10/27/1992	Nakamura	01/15/1991	US Application No. 12/228,180
JP 61-264371	11/22/1986			JP Application No. 2004-534603 related to US 7,120,250